PA	TE	NT
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Attorney's Docket No.	
Attorney & Docker 140.	_

YES

NO

COMBINED DECLARATION AND POWER OF ATTORNEY

COM	BINED DECLARATION AND	O TOWER OF THE LOSS				
As below named inventor, I h	ereby declare that					
	n [] supplemental PCT ntinuation [] continuation-in-pa					
End and and inventor life and	dress, and citizenship are as state by one name is listed below) or an atter which is claimed and for wh	i original, lirst, aliu loutt	HIACH	ω_{i} μ_{i}	uinu	1111C3 W/C
LEAD FORMIN	G FOR A SEMICONDUCTOR	R DEVICE				
the specification of which: [X] is attached [] was as fi	hereto.	pplication No.			8	and was
amended of was filed by	on (if a _i	pplicable). , as Applic	cation	No. not k	known	yet, and
was amend	hereto. led on All on (if a led on if a led on ribed and claimed in PCT in and as amended	(if applicable). nternational Application under PCT Article 19 or	No.		-	filed on
I acknowledge the duty to accordance with Title 37, Co	viewed and understand the conte amendment referred to above. disclose information which is ode of Federal Regulations, § 1.5	material to the patent 6.	ability	of this	applic	cation in
patent or inventor's certificate the United States of America	te or of any PCT international area listed below and have also id PCT international application(s) me on the same subject matter l	entified below any forei	gn app	olication(s) for than th	patent or ne United
COUNTRY	APPLICATION	DATE OF FILING (day,month,year)		NDER 3		
Japan	2003-1242	07,01,2003	х	YES		NO
·		·		YES		NO

I hereby claim the benefit pursuant to Title 35, United States Code, § 119(e) of the following United States provisional application(s):

	APPLICATIONS CLAIMING NDER 35 USC 119(e)		
APPLICATION NO.	DATE OF FILING		
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l .			

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) or PCT international application(s) designating the United States of America that is/are listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in that/those prior application(s) in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, § 1.56 which occurred between the filing date of the prior application(s) and the national or PCT international filing date of this application.

							
PRIOR 1	U.S. A. DESIGN	PPLICATION TO THE PROPERTY OF	ONS OR PCT INTERI HE U.S. FOR BENEF	NATIONAL AF IT UNDER 35 U	PLICATIONS JSC 120		
U.S. APPLICATIONS				Status (check one)			
U.S. APPLICATION	S	. U.S. FILING DATE		PATENTED	PENDING	ABANDONED	
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2.0/							
3.0/					<u> </u>		
PCT APPLICAT	ONS DESIGNATING THE U.S.			Status (check one)			
PCT APPLICATION NO.	1	T FILING DATE	U.S. APPLN. NOS. ASSIGNED (if any)	PATENTED	PENDING	ABANDONED	
4.							
5.							
6.							

DETAILS (UNDE	OF FOREIGN APPL ER 35 USC 119 FOR	ICATIONS FROM WHI ABOVE LISTED U.S./I	CH PRIORITY CLAI	MED S
ABOVE APPLN. No.	Country	APPLICATION NO.	DATE OF FILING (day,month,yr)	DATE OF ISSUE (day,month,yr)
1.				
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As a named inventor, I hereby appoint the following registered practitioner(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith: Customer Number 23548.



I further direct that correspondence concerning this application be directed to Customer Number 23548.



I hereby declare that all statements made herein of my own knowledge are true, that all statements made on information and belief are believed to be true, that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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DECLBLK (Rev. 3/13/2000)